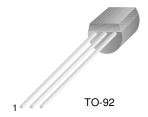


BF240

NPN RF Transistor



1. Collector 2. Emitter 3. Base

Absolute Maximum Ratings* T_a =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	40	V
V _{EBO}	Emitter-Base Voltage	4.0	V
I _C	Collector Current - Continuous	50	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Electrical Characteristics T_a =25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charact	eristics		•		•
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	I _C = 1.0mA, I _B = 0	40		V
V _{(BR)CBO}	Collector-Base BreakdownVoltage	$I_C = 100\mu A, I_E = 0$	40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	4.0		V
I _{CBO}	Collector Cut-off Current	V _{CB} = 20V, I _E = 0		100	nA
On Charact	eristics		•		•
h _{FE}	DC Current Gain	I _C = 1mA, V _{CE} = 10V	65	225	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_{C} = 1 \text{mA}, I_{B} = 0.1 \text{mA}$		0.65	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_{C} = 1 \text{mA}, I_{B} = 0.1 \text{mA}$		0.74	V
Small Signa	Il Characteristics		•	•	
f _T	Current gain Bandwidth Product	$I_C = 7.0 \text{mA}, V_{CE} = 10 \text{V},$ f = 100MHz		1100	MHz
C _{re}	Common-Emitter Ruerse Transfer Capacitance	$V_{CB} = 10V, I_{E} = 0, f = 1.0MHz$		0.34	pF

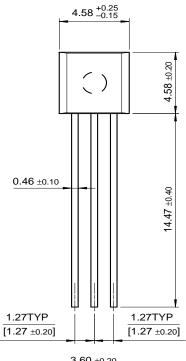
^{*} Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

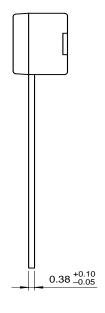
Thermal Characteristics $T_A=25$ °C unless otherwise noted

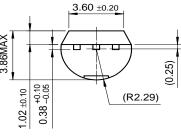
Symbol	Parameter	Max.	Units
P _D	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

Package Dimensions

TO-92







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The Power Franch Programmable Ac	 PACMAN [™] POP [™]	Stealth™ SuperSOT™-3	

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result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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